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Product Change Notification

Change Notification #: 118553-00

Change Title: Select Intel® NUC Pro Chassis Element

CMCM2FB

Intel® NUC Pro Chassis Element

CMCM2FBAV

PCN 118553-00, Label, Product Marking Change CB logo on rating label from UL to

NTRL

Date of Publication: October 08, 2021

Key Characteristics of the Change:

Label, Product Marking

Forecasted Key Milestones:

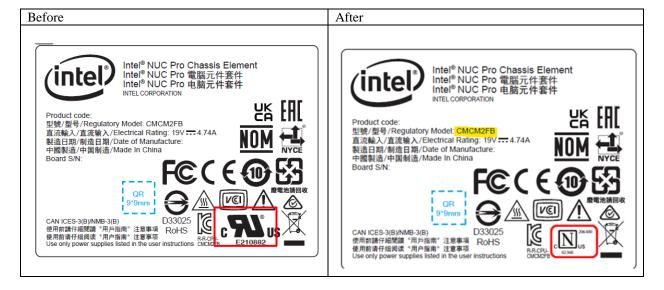
Date Customer Must be Ready to Receive Post-Conversion Material	October 30, 2021
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Description of Change to the Customer:

The Intel SKUs listed in the products affected table will have the following changes.

Change CB logo on rating label from UL to NTRL due to Lab convert from UL CB to Nemko NRTL CB.

Rating label with NTRL logo



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Customer Impact of Change and Recommended Action:

The change to the rating label does not affect the functionality of the product. Customer should be aware of these changes and take any actions so as to not impact their receiving and integration of product with the new labels. Customer should review the updated regulatory documentation as needed for any impact to country regulatory requirements.

Milestone dates are estimates and subject to change based on business and operational conditions.

Customer can expect to receive mixed inventory until current inventory levels are depleted.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change SA	Post Change SA
Intel® NUC Pro Chassis Element CMCM2FBAV, no cord, 5 pack	BKCMCM2FBAV	99A2N5	K93663-204	K93663-205
Intel® NUC Pro Chassis Element CMCM2FBAV, US cord, 5 pack	BKCMCM2FBAV1	99A2NJ	K93663-204	K93663-205
Intel® NUC Pro Chassis Element CMCM2FBAV, EU cord, 5 pack	BKCMCM2FBAV2	99A2NZ	K93663-204	K93663-205
Intel® NUC Pro Chassis Element CMCM2FBAV, UK cord, 5 pack	BKCMCM2FBAV3	99A2P0	K93663-204	K93663-205
Intel® NUC Pro Chassis Element CMCM2FBAV, AU cord, 5 pack	BKCMCM2FBAV4	99A2P1	K93663-204	K93663-205
Intel® NUC Pro Chassis Element CMCM2FB, no cord, 5 pack	BKCMCM2FB	99A2P2	K93662-204	K93662-205
Intel® NUC Pro Chassis Element CMCM2FB, US cord, 5 pack	BKCMCM2FB1	99A2P3	K93662-204	K93662-205
Intel® NUC Pro Chassis Element CMCM2FB, EU cord, 5 pack	BKCMCM2FB2	99A2P6	K93662-204	K93662-205
Intel® NUC Pro Chassis Element CMCM2FB, UK cord, 5 pack	BKCMCM2FB3	99A2PC	K93662-204	K93662-205
Intel® NUC Pro Chassis Element CMCM2FB, AU cord, 5 pack	BKCMCM2FB4	99A2PD	K93662-204	K93662-205

PCN Revision History:

Date of Revision: Revision Number: Reason:

October 08, 2021 00 Originally Published PCN

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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